

# SHROUDED **HEADERS & STACKERS**

(1.27 mm) .050" PITCH • TML/ZML SERIES



## TML/ZML

Mates:

SMS, RSM

# **SPECIFICATIONS**

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Phosphor Bronze
Plating:
Au or Sn over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +105 °C with Tin;
-55 °C to +125 °C with Gold

### ZML

Insulator Material: Black Liquid Crystal Polymer **Terminal Material:** 

Phosphor Bronze Plating:

Au or Sn over 50 μ" (1.27 μm) Ni Operating Temp Range: -55 °C to +105 °C with In; -55 °C to +125 °C with Gold

# **PROCESSING**

#### **TML** Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (05-20) (0.15 mm) .006" max (32)\* \*(.004" stencil solution may be available; contact IPG@samtec.com)

# ZML

Same as TML except:

SMT Lead Coplanarity: (0.15 mm) .006" max\* \*(.004" stencil solution may be available; contact ipg@samtec.com)

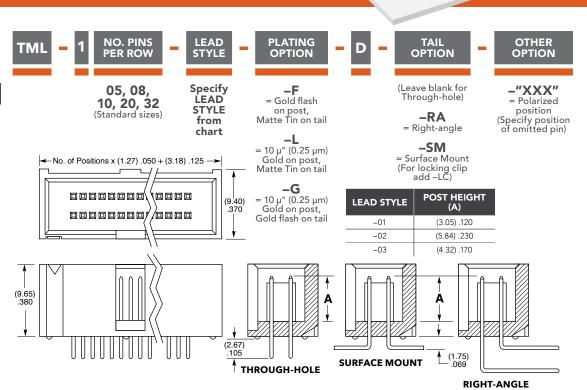
# **ALSO AVAILABLE**

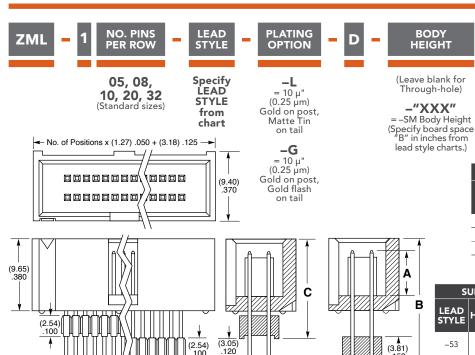
Other sizes Other platings

#### Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

Some sizes, styles and options are non-standard, non-returnable.





**THROUGH-HOLE** 

**SURFACE MOUNT** 

.100

**TAIL** 

OPTION

(Leave blank for

Through-hole)

-SM

= Surface

Mount

BODY HEIGHT (C)

(12.83) .505

(14.22) .560

(16.64) .655

(19.69) .775

BODY HEIGHT

(B)

(13.46) to (20.19)

(13.46) to (17.40)

.795

.685

.530

.530

THROUGH-HOLE

STYLE

-01

-02

-03

-04

POST HEIGHT

(A)

(3.05)

.120

(5.84)

.230

-54

**SURFACE MOUNT**